

Vishay Siliconix

N-Channel 60 V (D-S) MOSFET



Marking code: G3

PRODUCT SUMMARY					
V _{DS} (V)	60				
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 10 \text{ V}$	0.144				
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 4.5 \text{ V}$	0.200				
Q _g typ. (nC)	1.05				
I _D (A) ^d	2.6				
Configuration	Single				

FEATURES

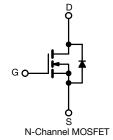
- TrenchFET® Gen IV power MOSFET
- 100 % R_g tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

Pb-free RoHS

ROHS COMPLIANT HALOGEN FREE

APPLICATIONS

- · Battery switch
- DC/DC converter
- · Load switch



ORDERING INFORMATION	
Package	SOT-23
Lead (Pb)-free and halogen-free	Si2308CDS-T1-GE3

PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V _{DS}	60	V
Gate-source voltage		V _{GS}	± 20	V
	T _C = 25 °C		2.6	
Continuous dusin surrent (T. 150 °C)	T _C = 70 °C	1 .	2.1	
Continuous drain current (T _J = 150 °C)	T _A = 25 °C	I _D	1.9 ^{a, b}	
	T _A = 70 °C		1.5 ^{a, b}	
Pulsed drain current (t = 100 μs)		I _{DM}	6	A
Continuous source-drain diode current	T _C = 25 °C		1.3	
	T _A = 25 °C	I _S	0.72 ^{a, b}	
Single pulse avalanche current	L = 0.1 mH	I _{AS}	4	
Single pulse avalanche energy	L=0.1 min	E _{AS}	0.8	mJ
Maximum power dissipation	T _C = 25 °C		1.6	
	T _C = 70 °C	1 , [1	14/
	T _A = 25 °C	P _D	0.9 ^{a, b}	w
	T _A = 70 °C	1	0.6 ^{a, b}	
Operating junction and storage temperature range		T _J , T _{stq}	-55 to +150	°C

THERMAL RESISTANCE RATINGS							
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT		
Maximum junction-to-ambient a, c	t ≤ 10 s	R _{thJA}	120	145	°C/W		
Maximum junction-to-foot (drain)	Steady state	R_{thJF}	62	78	C/VV		

Notes

- a. Surface mounted on 1" x 1" FR4 board
- b. t = 10 s
- c. Maximum under steady state conditions is 175 °C/W
- d. $T_C = 25$ °C

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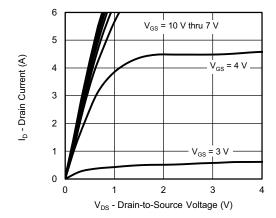
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static	•		I.			
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	60	-	-	٧
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	J 050 A	-	40	-	
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-4.5	-	mV/°C
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1	-	3	V
Gate-source leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
Zana alian allama darka a mad		V _{DS} = 60 V, V _{GS} = 0 V	-	-	1	μΑ
Zero gate voltage drain current	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V, T _J = 70 °C	-	-	10	
On-state drain current ^a	I _{D(on)}	$V_{DS} \le 10 \text{ V}, V_{GS} = 10 \text{ V}$	6	-	-	Α
5		V _{GS} = 10 V, I _D = 1.9 A	-	0.120	0.144	Ω
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 1.5 \text{ A}$	-	0.160	0.200	
Forward transconductance a	9 _{fs}	V _{DS} = 30 V, I _D = 1.9 A	-	3.2	-	S
Dynamic ^b	•		I.	1		ı
Input capacitance	C _{iss}		-	105	-	pF
Output capacitance	C _{oss}	V _{DS} = 30 V, V _{GS} = 0 V, f = 1 MHz	-	55	-	
Reverse transfer capacitance	C _{rss}		-	7	-	
Total gate charge	Qg	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 1.9 \text{ A}$	-	2	4	nC
			-	1.05	2.1	
Gate-source charge	Q _{gs}	$V_{DS} = 30 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 1.9 \text{ A}$	-	0.62	-	
Gate-drain charge	Q_{gd}		-	0.17	-	
Gate resistance	R_g	f = 1 MHz	0.3	1.5	3	Ω
Turn-on delay time	t _{d(on)}		-	8	16	
Rise time	t _r	$V_{DD} = 30 \text{ V}, R_1 = 20 \Omega, I_D \cong 1.5 \text{ A},$	-	5	10	1
Turn-off delay time	t _{d(off)}	$V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	11	20	
Fall time	t _f		-	3	6	
Turn-on delay time	t _{d(on)}		-	23	35	ns
Rise time	t _r	$V_{DD} = 30 \text{ V}, R_1 = 20 \Omega, I_D \cong 1.5 \text{ A},$	-	25	40	=
Turn-off delay time	t _{d(off)}	$V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$	-	10	20	
Fall time	t _f		-	16	30	
Drain-Source Body Diode Characteristi	cs		L	l .	L	
Continuous source-drain diode current	Is	T _C = 25 °C	-	-	1.7	
Pulse diode forward current	I _{SM}		-	-	4	A
Body diode voltage	V _{SD}	I _S = 1.5 A, V _{GS} = 0 V	-	0.85	1.2	V
Body diode reverse recovery time	t _{rr}		-	15	30	ns
Body diode reverse recovery charge	Q _{rr}		-	53	80	nC
Reverse recovery fall time	t _a	$I_F = 1.5 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$	-	27	-	
Reverse recovery rise time	t _b		_	17	_	ns

Notes

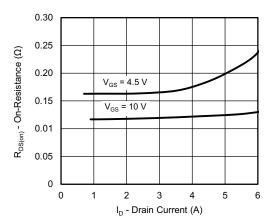
- a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

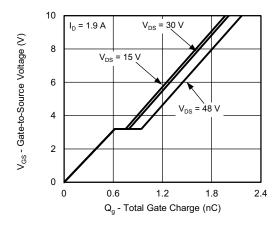




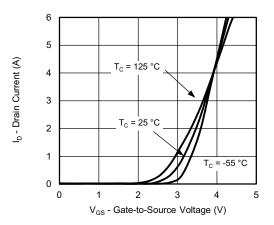
Output Characteristics



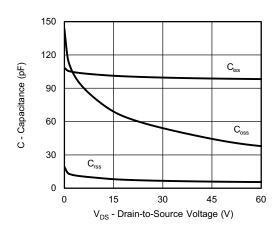
On-Resistance vs. Drain Current and Gate Voltage



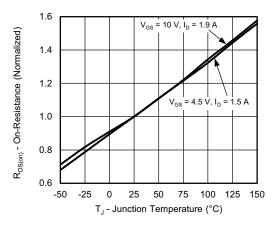
Gate Charge



Transfer Characteristics

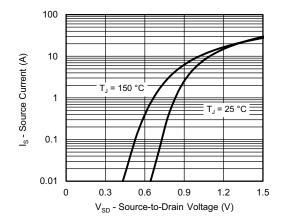


Capacitance

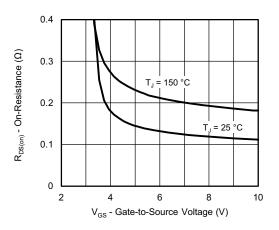


On-Resistance vs. Junction Temperature

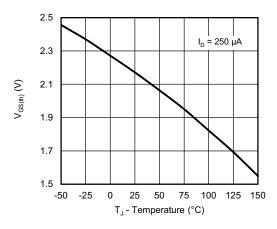




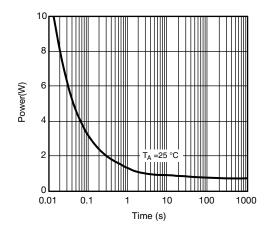
Source-Drain Diode Forward Voltage



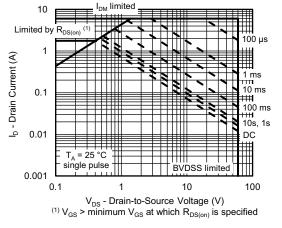
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage

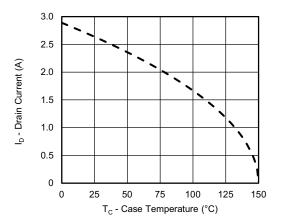


Single Pulse Power, Junction-to-Ambient

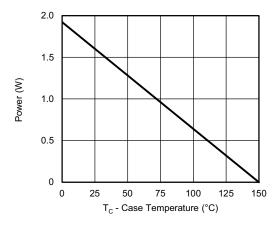


Safe Operating Area, Junction-to-Ambient

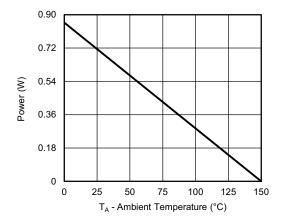




Current Derating a





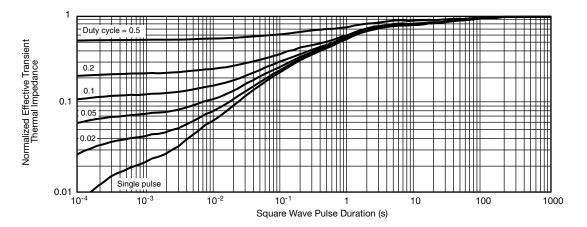


Power, Junction-to-Ambient

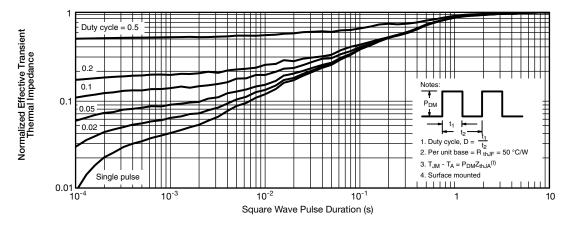
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



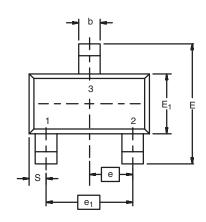
Normalized Thermal Transient Impedance, Junction-to-Case

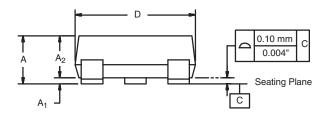
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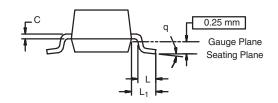


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SOT-23 (TO-236): 3-LEAD







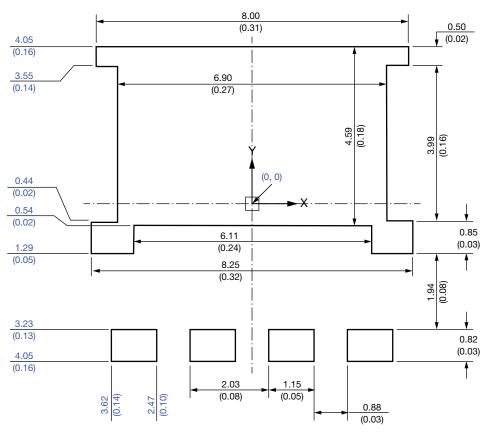
Dim —	MILLIN	IETERS	INCHES		
	Min	Max	Min	Max	
Α	0.89	1.12	0.035	0.044	
A ₁	0.01	0.10	0.0004	0.004	
A ₂	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E ₁	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e ₁	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L ₁	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	
ECN: S-03946-Rev. K. 09-	Jul-01				

DWG: 5479

Document Number: 71196 www.vishay.com 09-Jul-01



Recommended Minimum PADs for PowerPAK® 8 x 8L Single



Dimensions in millimeters (inches)

Note

• Linear dimensions are in black, the same information is provided in ordinate dimensions which are in blue.



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